

MOSFETs Silicon P-Channel MOS (U-MOSVI)

SSM3J168F

1. Applications

- · High-Speed Switching
- · Analog Switches
- · Interfacing

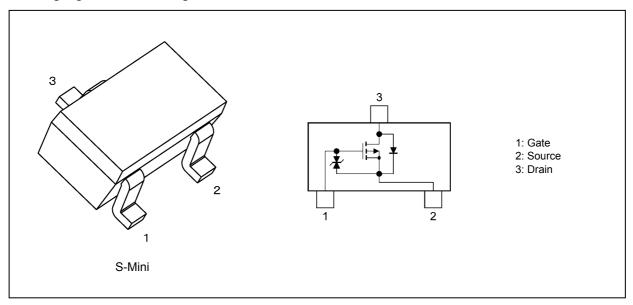
2. Features

- (1) AEC-Q101 qualified (Please see the orderable part number list)
- (2) 4.0 V drive
- (3) Low drain-source on-resistance
 - : $R_{DS(ON)} = 1.6 \Omega$ (typ.) ($V_{GS} = -4.0 \text{ V}$)

 $R_{\rm DS(ON)} = 1.4 \Omega \text{ (typ.) } (V_{\rm GS} = -4.5 \text{ V})$

 $R_{\mathrm{DS(ON)}} = 1.3 \Omega \text{ (typ.) } (V_{\mathrm{GS}} = -10 \text{ V})$

3. Packaging and Pin Assignment



4. Orderable part number

Orderable part number	AEC-Q101 Note				
SSM3J168F,LF	_		General Use		
SSM3J168F,LXGF	YES	(Note 1)	Unintended Use (Note		
SSM3J168F,LXHF	YES		Automotive Use		

Note 1: For more information, please contact our sales or use the inquiry form on our website.

Start of commercial production



5. Absolute Maximum Ratings (Note) (Unless otherwise specified, Ta = 25 °C)

Characteristics			Symbol	Rating	Unit
Drain-source voltage			V_{DSS}	-60	V
Gate-source voltage			V_{GSS}	-20/+10	
Drain current (DC)		(Note 1)	I_D	-400	mA
Drain current (pulsed)		(Note 1)	I _{DP}	-800	
Power dissipation		(Note 2)	P_{D}	600	mW
Power dissipation	t ≤ 1s	(Note 2)		1200	
Channel temperature			T _{ch}	150	°C
Storage temperature			T _{stg}	-55 to 150	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Ensure that the channel temperature does not exceed 150 °C.

Note 2: Device mounted on a 25.4 mm × 25.4 mm × 1.6 mm FR4 glass epoxy board (Cu pad: 645 mm²)

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

Note: The MOSFETs in this device are sensitive to electrostatic discharge. When handling this device, the worktables, operators, soldering irons and other objects should be protected against anti-static discharge.

Note: The channel-to-ambient thermal resistance, $R_{th(ch-a)}$, and the drain power dissipation, P_D , vary according to the board material, board area, board thickness and pad area. When using this device, be sure to take heat dissipation fully into account.



6. Electrical Characteristics

6.1. Static Characteristics (Unless otherwise specified, Ta = 25 °C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = -16 \text{ V}/+10 \text{ V}$	_	_	±10	μА
Drain cut-off current		I _{DSS}	V _{DS} = -60 V, V _{GS} = 0 V	_	_	-10	
Drain-source breakdown voltage		V _{(BR)DSS}	I _D = -1 mA, V _{GS} = 0 V	-60	_	_	٧
Drain-source breakdown voltage	(Note 1)	V _{(BR)DSX}	I _D = -1 mA, V _{GS} = 10 V	-50	_	_	
Gate threshold voltage	(Note 2)	V _{th}	V _{DS} = -10 V, I _D = -1 mA	-0.8	_	-2.0	
Drain-source on-resistance	(Note 3)	R _{DS(ON)}	I _D = -100 mA, V _{GS} = -4.0 V	_	1.6	2.0	Ω
			I _D = -100 mA, V _{GS} = -4.5 V	_	1.4	1.9	
			I _D = -200 mA, V _{GS} = -10 V	_	1.3	1.55	

Note 1: If a reverse bias is applied between gate and source, this device enters $V_{(BR)DSX}$ mode. Note that the drain-source breakdown voltage is lowered in this mode.

Note 2: Let V_{th} be the voltage applied between gate and source that causes the drain current (I_D) to below (-1 mA for this device). Then, for normal switching operation, $V_{GS(ON)}$ must be higher than V_{th} , and $V_{GS(OFF)}$ must be lower than V_{th} . This relationship can be expressed as: $V_{GS(OFF)} < V_{th} < V_{GS(ON)}$.

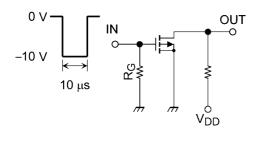
Take this into consideration when using the device.

Note 3: Pulse measurement.

6.2. Dynamic Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance	C _{iss}	V _{DS} = -10 V , V _{GS} = 0 V,	1	82	_	pF
Reverse transfer capacitance	C_{rss}	f = 1 MHz		5.5		
Output capacitance	C _{oss}		_	13		
Switching time (turn-on time)	t _{on}	V_{DD} = -30 V, I_{D} = -0.1 A, V_{GS} = 0 to -10 V, R_{G} = 50 Ω		4.3		ns
Switching time (turn-off time)	t _{off}	Duty \leq 1 %,V _{IN} : t_r , t_f < 5 ns, Common source		31.7		

6.3. Switching Time Test Circuit



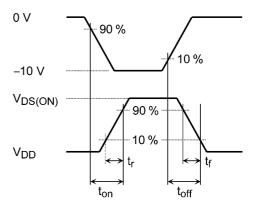


Fig. 6.3.1 Switching Time Test Circuit

Fig. 6.3.2 Input Waveform/Output Waveform

6.4. Gate Charge Characteristics (Unless otherwise specified, Ta = 25 °C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge (gate-source plus gate-drain)		$V_{DD} = -48 \text{ V}, I_{D} = -0.4 \text{ A},$	_	3.0		nC
Gate-source charge 1	Q _{gs1}	V _{GS} = -10 V		0.4		
Gate-drain charge	Q _{gd}		_	1.1		

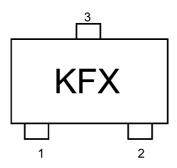


6.5. Source-Drain Characteristics (Unless otherwise specified, Ta = 25 °C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Diode forward voltage	(Note 1)	V_{DSF}	$I_D = 400 \text{ mA}, V_{GS} = 0 \text{ V}$	_	0.87	1.2	٧

Note 1: Pulse measurement.

7. Marking





8. Characteristics Curves (Note)

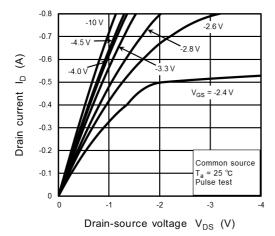


Fig. 8.1 $I_D - V_{DS}$

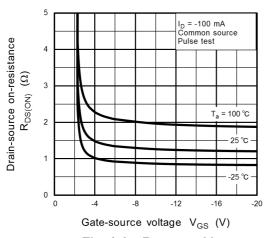


Fig. 8.3 R_{DS(ON)} - V_{GS}

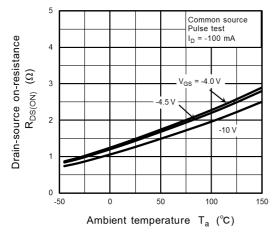


Fig. 8.5 R_{DS(ON)} - T_a

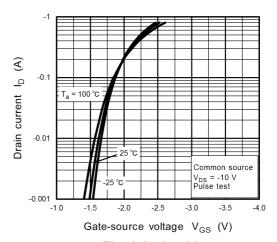


Fig. 8.2 I_D - V_{GS}

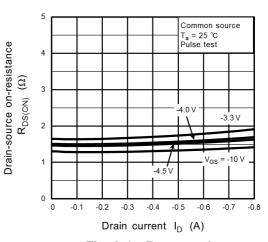


Fig. 8.4 R_{DS(ON)} - I_D

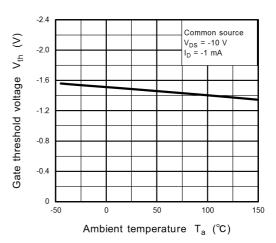


Fig. 8.6 V_{th} - T_a



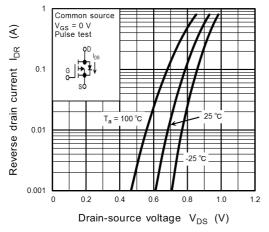


Fig. 8.7 IDR - VDS

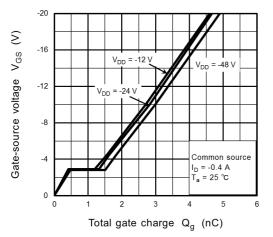


Fig. 8.9 Dynamic Input Characteristics

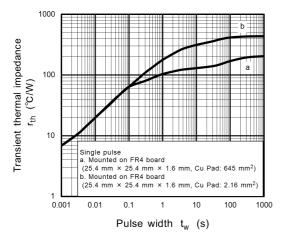


Fig. 8.11 r_{th} - t_w

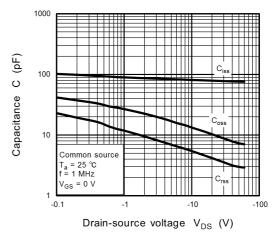


Fig. 8.8 C - V_{DS}

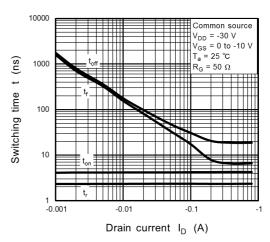


Fig. 8.10 t - I_D

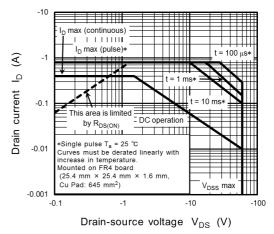


Fig. 8.12 Safe Operationg Area



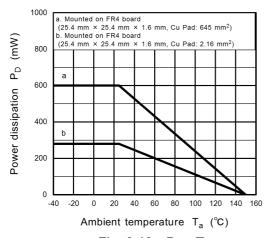


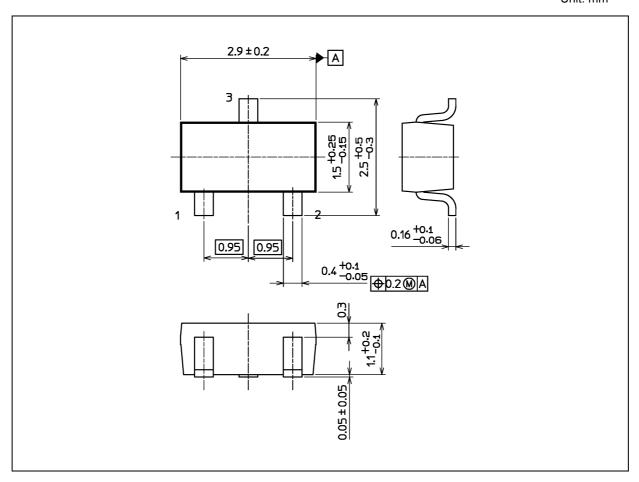
Fig. 8.13 P_D - T_a

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



Package Dimensions

Unit: mm



Weight: 12 mg (typ.)

	Package Name(s)
JEDEC: SOT-346	
Nickname: S-Mini	



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